

Excellent Integrated System Limited

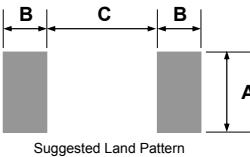
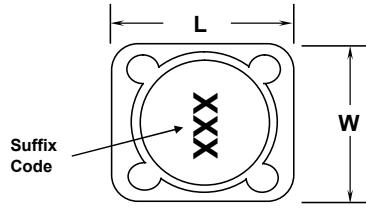
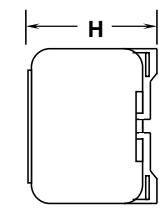
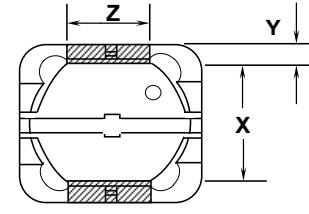
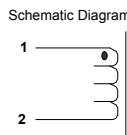
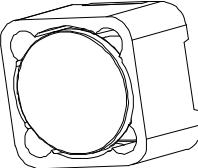
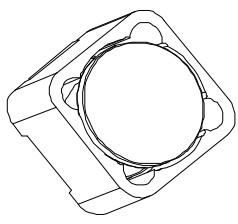
Stocking Distributor

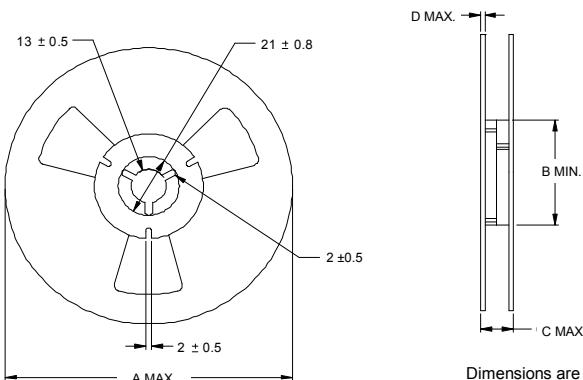
Click to view price, real time Inventory, Delivery & Lifecycle Information:

[TE Connectivity](#)
[MGQD2-00001](#)

For any questions, you can email us directly:

sales@integrated-circuit.com

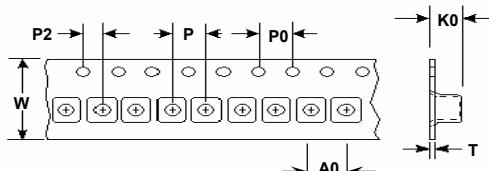
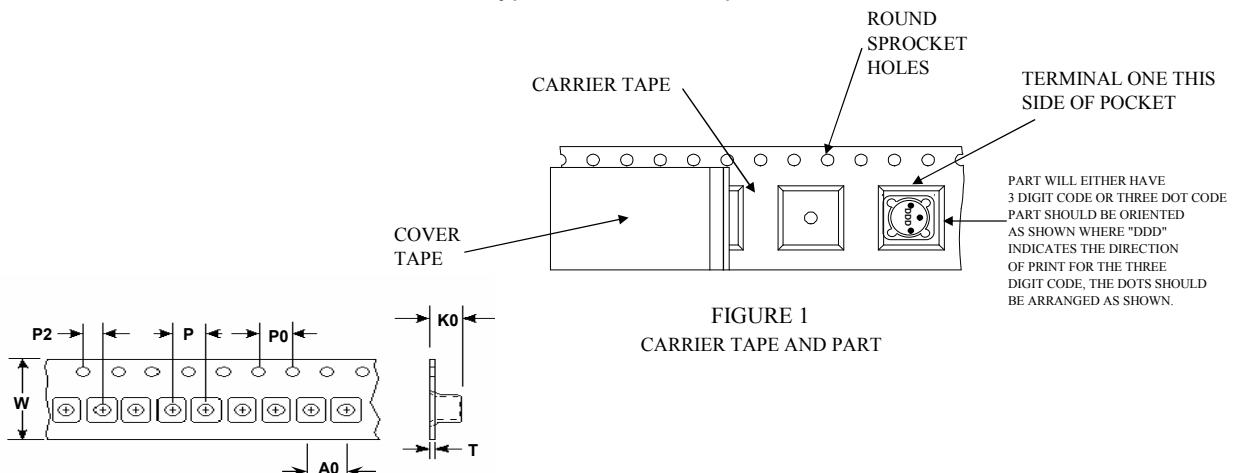
SERIES:	 Low Profile, High Current Power Inductors		3003 9th Avenue SW PO Box 50 Watertown, SD 57201 Toll free: 888-978-2638 Ph: 605-886-3326 Fax: 605-886-8995							
   										
Series Number	Maximum Dimensions			Reference Dimensions						
MGDQ2	Units inches [mm]	L 0.256" [6.50]	W 0.272" [6.90]	H 0.197" [5.00]	X 0.181" [4.60]	Y 0.043" [1.10]	Z 0.063" [1.60]	A 0.069" [1.75]	B 0.049" [1.25]	C 0.171" [4.35]
Features: <ul style="list-style-type: none"> • High energy storage and low resistance • Reliable surface mounting, flat top for pick and place. • Smaller real estate than other common inductors. • Robust temperature deflection to prevent damage during solder reflow. • Tape and Reel mechanical specifications available upon request. • Operating Temperature -40°C to +85°C. • Highly resistive core for EMI suppression applications. 										
 260°C Maximum reflow temperature per J-STD020C Terminal Plating is Gold Flash over Ni										
										
 										
Contact CoEv for additional inductance values										
Specifications subject to change.										
Call Toll Free: 888-978-2638 Website: www.tycopowercomponents.com										
										



Dimensions are in millimeters unless specified.

Series Number	Reel dimensions				Reel Qty	Carton (Box) Qty.	Packaging Specification	
	Units	A	B	C				
MGKDQ2	in. [mm]	14.17" [360]	3.94" [100.0]	0.88" [22.4]	0.098" [2.50]	1000	6000	90-0044

PACKAGING NOTE: Only pressure sensitive cover tape is to be used.



Series	W ± 0.3	P ± 0.1	P0 ± 0.1	P2 ± 0.1	K0 ± 0.05	T ± 0.05	A0 ± 0.1
MGKDQ2	16.0	12.0	4.00	2.00	5.15	0.35	7.3



Customer Packaging Specifications
For Print Distribution to Customers

Series	Revision
MGKDQ2	A

Item	Specification	Test Method/Condition						
Environmental								
Static Humidity	After exposure part remains within specified electrical parameters for L, Q and DCR.	Precondition at 25°C for 60 minutes. Expose parts to an environment of +40°C with 90 to 95% R.H. for 240 hours.						
Storage Life	After exposure part remains within specified electrical parameters for L, Q and DCR.	Subject parts to an environment of 85°C 85% R.H. for 168 hours. After exposure allow parts to dry for 4 hours before measurements are taken.						
Temperature Cycle	After exposure part remains within specified electrical parameters for L, Q and DCR.	10 cycles (Air to Air) 1 cycle shall consist of: 30 minutes exposure to +85°C 30 minutes exposure to -40°C Allow 20 minutes transition between extremes.						
Temperature Shock	After exposure part remains within specified electrical parameters for L, Q and DCR.	10 cycles (Air to Air) 1 cycle shall consist of: 30 minutes exposure to -55°C 30 minutes exposure to +125°C 15 seconds maximum transition between temperatures						
IR Reflow	10 seconds at 260°C max.	Post test parts shall pass all electrical specifications after reflow. There shall be no visible signs of solder flow or leakage from the part.						
General								
Storage Temperature Range	-40°C to +85°C							
Operating Temperature Range	-40°C to +85°C							
Flammability	IEC 695-2-2	Withstands needle-flame test						
Other								
Vibration	After exposure part remains within specified electrical parameters for L, Q and DCR.	1 cycle of 30 minutes of the following: 5 - 7 Hz constant displacement of 0.75 inches, 5 minutes 7 - 30 Hz constant acceleration of 1.5 Gs, 10 minutes 31 - 50 Hz constant displacement of 0.33 inches, 5 minutes 50 - 500 Hz constant acceleration of 1.2 Gs, 10 minutes						
Mechanical Shock	After exposure part remains within specified electrical parameters for L, Q and DCR.	MGKDQ2 Series - 500 Gs per axis, 2 directions						
Solderability	Wetting shall cover 90% minimum of each termination	Dip pads in RMA flux, 63/37 solder (Sn/Pb) at 232°C for 5 seconds ±2 seconds.						
Component Adhesion (Push Test)	Component shall withstand 6 lb. push force minimum without delaminating from mounting surface.	Apply and measure force with a digital force gauge set.						
Resistance to Solvent		Withstands 6 minutes of alcohol.						
		Withstands 3 minutes forced spray Freon TMS						
Chemical								
Ionic Contamination	Conductivity: pH: Chlorides: Sodium: Potassium:	11 µOhms/cm maximum 5.5 to 9 65 ppm maximum 20 ppm maximum 10 ppm maximum						
		 RoHS Compliant						
For Print Distribution to Customers		<table border="1"> <tr> <th>Series</th><th>Revision</th></tr> <tr> <td>MGKDQ2</td><td>A</td></tr> <tr> <td></td><td></td></tr> </table>	Series	Revision	MGKDQ2	A		
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